



Features

- Single 3-V Supply Voltage
- High-power-added Efficient Power Amplifier (P_{out} Typically 28 dBm)
- Ramp-controlled Output Power
- Low-noise Preamplifier (NF Typically 2.1 dB)
- Biasing for External PIN Diode T/R Switch
- Current-saving Standby Mode
- Few External Components
- Package: QFN20

Description

The T7026 is a monolithic SiGe transmit/receive front-end IC with power amplifier, low-noise amplifier and T/R switch driver. It is especially designed for operation in TDMA systems like DECT, IEEE 802.11 FHSS WLAN, home RF and ISM proprietary radios. Due to the ramp-control feature and a very low quiescent current, an external switch transistor for V_S is not required.

Electrostatic sensitive device.

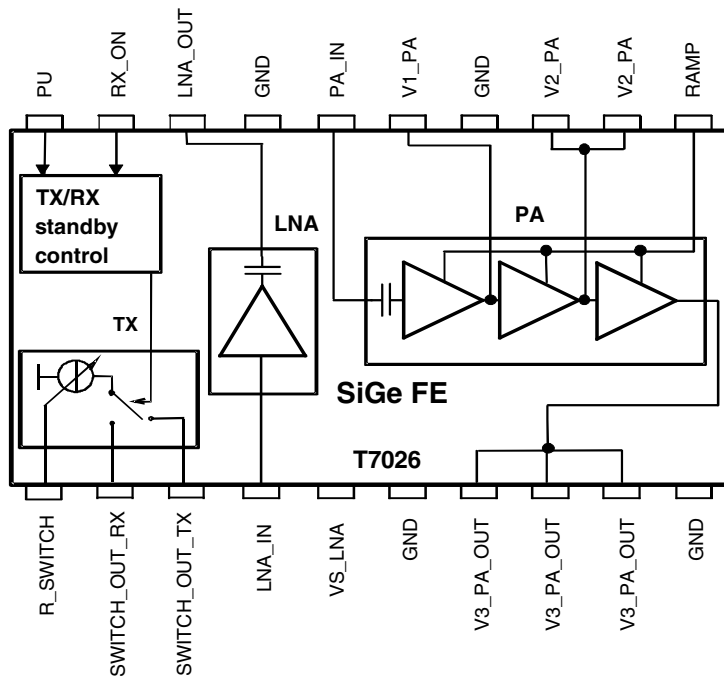
Observe precautions for handling.



ISM 2.4 GHz Front End IC

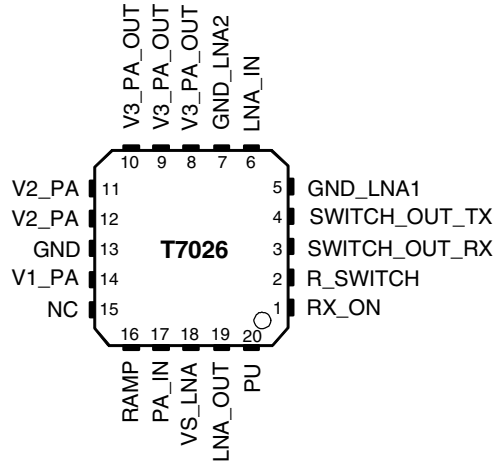
T7026

Figure 1. Block Diagram



Pin Configuration

Figure 2. Pinning QFN20



Pin Description

Pin	Symbol	Function
1	RX_ON	RX active high
2	R_SWITCH	Resistor to GND sets the PIN diode current
3	SWITCH_OUT_RX	Switched current output for PIN diode (active in RX mode)
4	SWITCH_OUT_TX	Switched current output for PIN diode (active in TX mode)
5	GND_LNA1	Ground
6	LNA_IN	Low-noise amplifier input
7	GND_LNA2	Ground
8	V3_PA_OUT	Inductor to power supply and matching network for power amplifier output
9	V3_PA_OUT	Inductor to power supply and matching network for power amplifier output
10	V3_PA_OUT	Inductor to power supply and matching network for power amplifier output
11	V2_PA	Inductor to power supply for power amplifier
12	V2_PA	Inductor to power supply for power amplifier
13	GND	Ground
14	V1_PA	Supply voltage for power amplifier
15	NC	Not connected
16	RAMP	Power ramping control input
17	PA_IN	Power amplifier input
18	VS_LNA	Supply voltage input for low-noise amplifier
19	LNA_OUT	Low-noise amplifier output
20	PU	Power-up active high
Slug	GND	Ground

Absolute Maximum Ratings

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

All voltages are referred to ground (pins GND and slug)

Parameters	Symbol	Value	Unit
Supply voltage Pins VS_LNA, V1_PA, V2_PA and V3_PA_OUT, no RF	V_S	5	V
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-40 to +125	°C
RF input power LNA	P_{inLNA}	-5 dBm	dBm
RF input power PA	P_{inPA}	10 dBm	dBm

Thermal Resistance

Parameters	Symbol	Value	Unit
Junction ambient QFN20, slug soldered on PCB	R_{thJA}	27	K/W

Operating Range

All voltages are referred to ground (pins GND and slug). Power supply points are VS_LNA, V1_PA, V2_PA, V3_PA_OUT. The following table represents the sum of all supply currents depending on the TX/RX mode.

Parameters	Symbol	Min.	Typ.	Max.	Unit
Supply voltage Pins V1_PA, V2_PA and V3_PA_OUT	V_S	2.7	3.6	4.6	V
Supply voltage Pin VS_LNA	V_S	2.7	3.0	5.5	V
Supply current TX	I_S		470		mA
RX	I_S		8		mA
Standby current PU = 0	I_S		10		μA
Ambient temperature	T_{amb}	-25	+25	+70	°C

Electrical Characteristics

Test conditions (unless otherwise specified): $V_S = 3.6\text{ V}$, $T_{amb} = 25^\circ\text{C}$

Parameters	Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Power Amplifier⁽¹⁾						
Supply voltage	Pins V1_PA, V2_PA and V3_PA_OUT	V_S	2.7	3.6	4.6	V
Supply current	TX	I_{S_TX}		470		mA
	RX (PA off), $V_{RAMP} \leq 0.1\text{ V}$	I_{S_RX}			10	μA
Standby current	Standby for $V_{RAMP} \leq 0.1\text{ V}$	$I_{S_standby}$			10	μA
Frequency range	TX	f	2.4		2.5	GHz
Gain-control range	TX	ΔGp	60	42		dB
Power gain maximum	TX	Gp	28	34	33	dB
Power gain minimum	Pin PA_IN to V3_PA_OUT	Gp	-40		-17	dB
Ramping voltage maximum	TX, power gain (max), pin RAMP	$V_{RAMP\ max}$	1.6	1.65	1.7	V
Ramping voltage minimum	TX, power gain (min), pin RAMP	$V_{RAMP\ min}$		1		V
Ramping current maximum	TX, $V_{RAMP} = 1.75\text{ V}$, pin RAMP	$I_{RAMP\ max}$			0.1	mA
Power-added efficiency	TX	PAE	33	37		%
Saturated output power	TX, input power = 0 dBm referred to pins V3_PA_OUT	P_{sat}	27	28	29	dBm
Input matching ⁽²⁾	TX pin PA_IN	Load VSWR		< 1.5:1		
Output matching ⁽²⁾	TX pins V3_PA_OUT	Load VSWR		< 1.5:1		
Harmonics at P 1dBCP	TX pins V3_PA_OUT	2 fo		-30		dBc
Harmonics at P 1dBCP	TX pins V3_PA_OUT	3 fo		-30		dBc
T/R-switch Driver (Current Programming by External Resistor from R_SWITCH to GND)						
Switch-out current output	Standby, pin SWITCH_OUT	$I_{S_O_standby}$			1	μA
	RX	$I_{S_O_RX}$			1	μA
	TX at 100 Ω	$I_{S_O_100}$		1.7		mA
	TX at 1.2 k Ω	$I_{S_O_1k2}$		7		mA
	TX at 33 k Ω	$I_{S_O_33k}$		17		mA
	TX at R switch open	$I_{S_O_R}$		19		mA
I_Switch_Out_RX maximum					7	mA
Low-noise Amplifier⁽³⁾						
Supply voltage	All, pin VS_LNA	V_S	2.7	3.0	5	V
Supply current	RX	I_S		8	10	mA
Supply current (LNA and control logic)	TX (control logic active) pin VS_LNA	I_S			0.5	mA
Standby current	Standby, pin VS_LNA	$I_{S_standby}$		1	10	μA
Frequency range	RX	f	2.4		2.5	GHz

Notes: 1. Power amplifier shall be unconditionally stable, maximum duty cycle 100%, true cw operation, maximum load mismatch and duration: VSWR = 8:1 (all phases) 10 s, ZG = 50 Ω , $V_S = 3.6\text{ V}$.

2. With external matching network, load impedance 50 Ω .

3. Low-noise amplifier shall be unconditionally stable.

4. With external matching components.

Electrical Characteristics (Continued)

Test conditions (unless otherwise specified): $V_S = 3.6\text{ V}$, $T_{amb} = 25^\circ\text{C}$

Parameters	Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Power gain	RX, pin LNA_IN to LNA_OUT	Gp	15	16	19	dB
Noise figure	RX	NF		2.1	2.3	dB
Gain compression	RX, referred to pin LNA_OUT	O1dB	-9	-7	-6	dBm
Third-order input interception point	RX	IIP3	-16	-14	-13	dBm
Input matching ⁽⁴⁾	RX, pin LNA_IN	VSWRin		< 2:1		
Output matching ⁽⁴⁾	RX, pin LNA_OUT	VSWRout		< 2:1		
Logic Input Levels (RX_ON, PU)						
High input level	= '1', pins RX_ON and PU	V_{iH}	2.4		$V_{S, LNA}$	V
Low input level	= '0'	V_{iL}	0		0.5	V
High input current	= '1', $V_{iH} = 2.4\text{ V}$	I_{iH}		40	60	μA
Low input current	= '0'	I_{iL}			0.2	μA

- Notes:
1. Power amplifier shall be unconditionally stable, maximum duty cycle 100%, true cw operation, maximum load mismatch and duration: VSWR = 8:1 (all phases) 10 s, ZG = 50 Ω , $V_S = 3.6\text{ V}$.
 2. With external matching network, load impedance 50 Ω .
 3. Low-noise amplifier shall be unconditionally stable.
 4. With external matching components.

Control Logic for LNA and T/R-switch Driver

Operation Mode	PU	RX_ON
Standby	0	0
TX	1	0
RX	1	1

Input/Output Circuits

Figure 3. Internal Circuitry; PA_IN, V1_PA

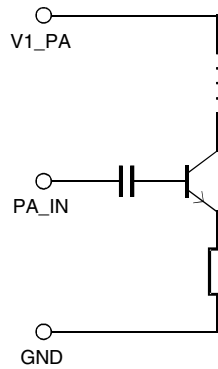


Figure 4. Internal Circuitry; RAMP, V1_PA

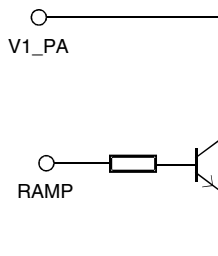


Figure 5. Internal Circuitry V2_PA

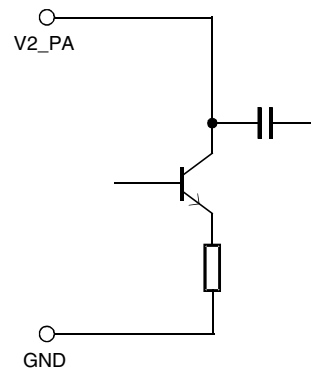


Figure 6. Internal Circuitry V3_PA_OUT

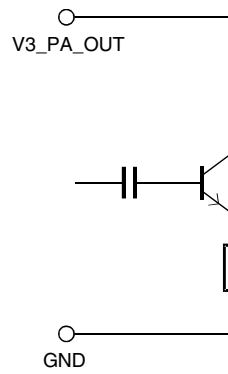


Figure 7. Internal Circuitry SWITCH_OUT_RX, SWITCH_OUT_TX, R_SWITCH, V1_PA

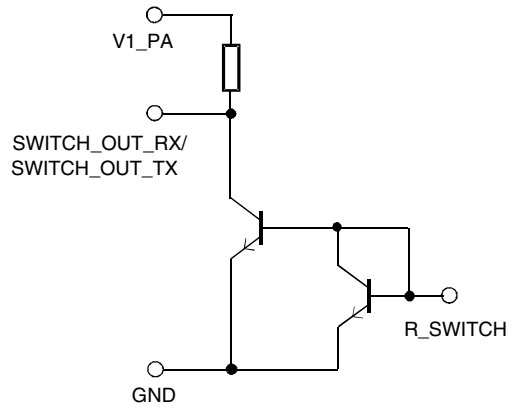


Figure 8. Internal Circuitry LNA_IN, VS_LNA

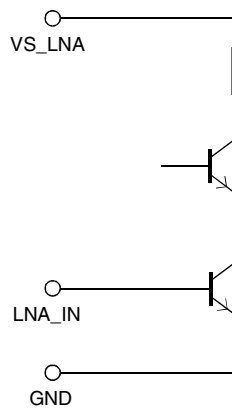


Figure 9. Internal Circuitry PU, RX_ON, VS_LNA

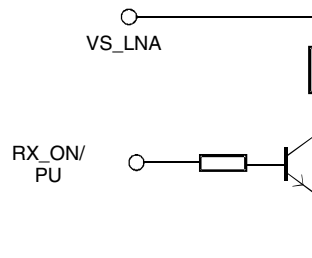
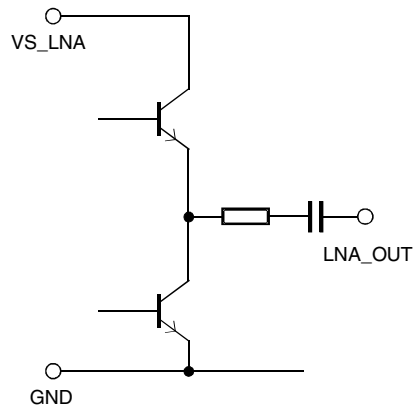


Figure 10. Internal Circuitry LNA_OUT, VS_LNA





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